

Si photodiode





S9674

Applicable to lead-free solder reflow and wide temperature range

The S9674 is a photodiode that is applicable to lead-free solder reflow and has an extremely wide operating and storage temperature range (-40 to +125 °C). The small and thin leadless package allows reducing the mount area on a printed circuit board.

Features

- **⇒** Suitable for lead-free solder reflow
- Surface mount type, small and thin leadless package
- → Operating/storage temperature: -40 to +125 °C
- → Photosensitive area: 2 × 2 mm
- \blacksquare High sensitivity: 0.7 A/W (λ =960 nm)

- Applications

- Rain sensor
- Sun sensor, etc.

■ Absolute maximum ratings

Parameter	Symbol	Value	Unit
Reverse voltage	VR max.	10	V
Operating temperature	Topr	-40 to +125	°C
Storage temperature	Tstg	-40 to +125	°C
Reflow soldering condition*1	Tsol	Peak temperature 260 °C, two times (see page 5)	-

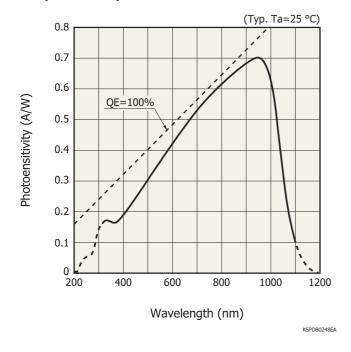
Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

➡ Electrical and optical characterisitcs (Ta=25 °C)

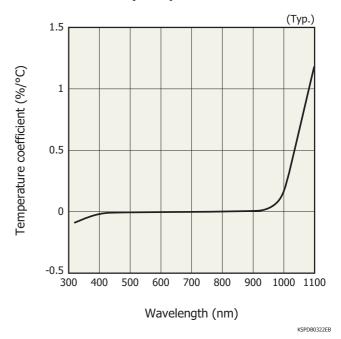
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Spectral response range	λ		-	320 to 1100	-	nm
Peak sensitivity wavelength	λр		-	960	-	nm
Photo sensitivity	S	λ=λρ	0.6	0.7	-	A/W
Short circuit current	Isc	100 lx, 2856 K	-	4.8	-	μΑ
Temperature coefficient of Isc	-		-	+0.1	-	%/°C
Half-value angle	-		-	±60	-	degree
Dark current	ID	VR=5 V	-	0.01	1	nA
Temperature coefficient of ID	TCID		-	1.12	-	times/°C
Rise time	tr	VR=0 V, RL=1 kΩ 10 to 90%	-	2	-	μs
Terminal capacitance	Ct	VR=0 V, f=10 kHz	-	500	-	pF

^{*1:} JEDEC level 4

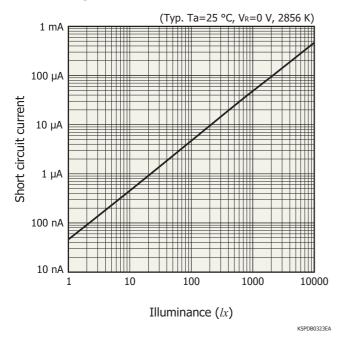
Spectral response



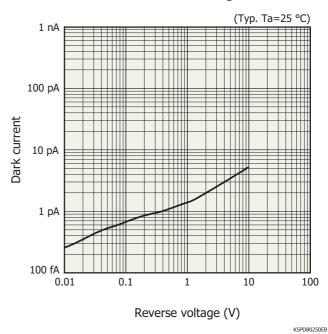
Photosensitivity temperature characteristics



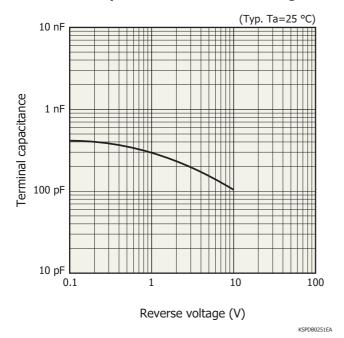
Linearity



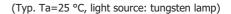
- Dark current vs. reverse voltage

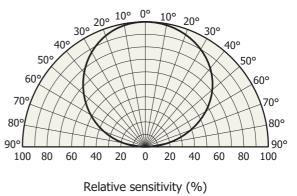


Terminal capacitance vs. reverse voltage

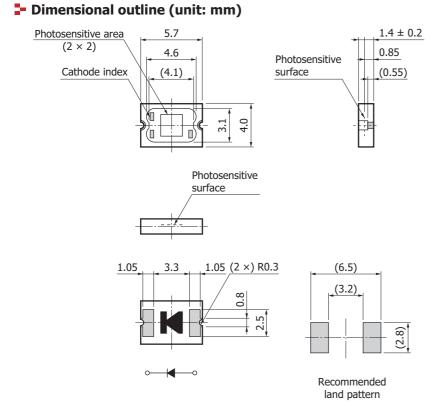


Directivity





KSPDB0249EA



Tolerance unless otherwise noted: ± 0.15 , $\pm 2^{\circ}$

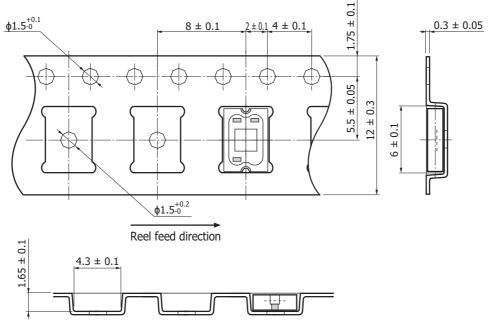
KSPDA0179EC

Standard packing specifications

■ Reel (conforms to JEITA ET-7200)

Dimensions	Hub diameter	Tape width	Material	Electrostatic characteristics
254 mm	100 mm	12 mm	Polystyrene	Conductive

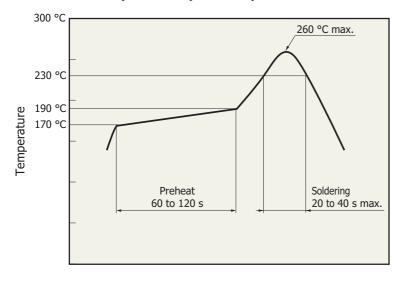
■ Embossed tape (unit: mm, material: polystyrene, conductive)



KSPDC0088EA

- Packing quantity 2000 pcs/reel
- Packing type
 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Measured example of temperature profile with our hot-air reflow oven for product testing



Time

- · This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 72 hours.
- · The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. Before actual reflow soldering, check for any problems by tesiting out the reflow soldering methods in advance.

- Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- · Disclaimer
- · Surface mount type products
- Technical information
- · Si photodiode / Application circuit examples

Information described in this material is current as of July, 2015.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use. Copying or reprinting the contents described in this material in whole or in part is prohibited without our prior permission.

AMAMATSU

www.hamamatsu.com

HAMAMATSU PHOTONICS K.K., Solid State Division

1.126-1 Ichino-cho, Higashi-ku, Hamamatsu City, 435-8558 Japan, Telephone: (81) 53-434-3311, Fax: (81) 53-434-5184
U.S.A.: Hamamatsu Corporation: 360 Foothill Road, Bridgewater, N.J. 08807, U.S.A., Telephone: (1) 908-231-0960, Fax: (1) 908-231-1218
Germany: Hamamatsu Photonics Deutschland GmbH: Arzbergerstr. 10, D-82211 Herrsching am Ammersee, Germany, Telephone: (49) 8152-375-0, Fax: (49) 8152-265-8
France: Hamamatsu Photonics France S.A.R.L.: 19, Rue du Saule Trapu, Parc du Moulin de Massy, 91882 Massy Cedex, France, Telephone: 33-(1) 69 53 71 00, Fax: 33-(1) 69 53 71 10 United Kingdom: Hamamatsu Photonics UK Limited: 2 Howard Court, 10 Tewin Road, Welvyn Garden City, Hertfordshire AL7 1BW, United Kingdom, Telephone: (44) 1707-294888, Fax: (44) 1707-325777 North Europe: Hamamatsu Photonics Norden AB: Torshamnsgatan 35 16440 Kista, Sweden, Telephone: (46) 8-509-031-00, Fax: (46) 8-509-031-01 Italy: Hamamatsu Photonics Italia S.r.l.: Strada della Moia, 1 int. 6, 20020 Arese (Milano), Italy, Telephone: (39) 02-93581733, Fax: (39) 02-93581741